

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- Green Device Available

Product Summary

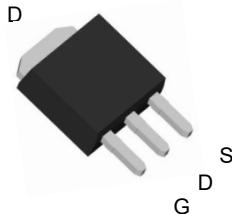


V_{DS}	30	V
I_D	50	A
$R_{DS(ON)}$ (at $V_{GS}=10V$)	8.5	mΩ
$R_{DS(ON)}$ (at $V_{GS}=4.5V$)	15	mΩ

Applications

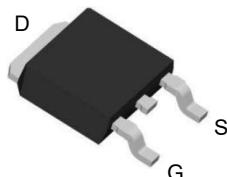
- High Frequency Point-of-Load,Synchronous Buck Converter
- Networking DC-DC Power System
- Load Switch

TO-251 Top View

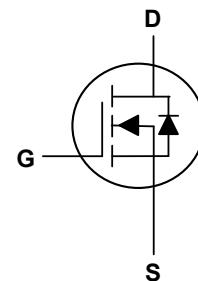


AT\$35\$0C

TO-252 Top View



AT\$35\$0K



Absolute Maximum Ratings($T_c=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ¹	I_D	50	A
Continuous Drain Current ¹	I_D	35	A
Pulsed Drain Current ²	I_{DM}	200	A
Single Pulse Avalanche Energy ³	EAS	72	mJ
Total Power Dissipation ⁴	P_D	58	W
Storage Temperature Range	T_{STG}	-55 to 150	°C
Operating Junction Temperature Range	T_J	-55 to 150	°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Unit
Thermal Resistance Junction-Case ¹	$R_{\theta JC}$	---	2.5	°C/W

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}$, $I_D=250\mu\text{A}$	30	---	---	V
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}=10\text{V}$, $I_D=20\text{A}$	---	6.5	8.5	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}$, $I_D=15\text{A}$	---	10	15	$\text{m}\Omega$
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{GS}}=V_{\text{DS}}$, $I_D=250\mu\text{A}$	1.0	1.5	2.5	V
Drain-Source Leakage Current	I_{DSS}	$V_{\text{DS}}=30\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=25^\circ\text{C}$	---	---	1	μA
Gate-Source Leakage Current	I_{GSS}	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	± 100	nA
Forward Transconductance	g_{fs}	$V_{\text{DS}}=5\text{V}$, $I_D=20\text{A}$	---	15	---	S
Total Gate Charge	Q_g	$V_{\text{DS}}=15\text{V}$, $V_{\text{GS}}=10\text{V}$, $I_D=20\text{A}$	---	32	---	nC
Gate-Source Charge	Q_{gs}		---	5	---	
Gate-Drain Charge	Q_{gd}		---	7	---	
Turn-On Delay Time	$T_{\text{d(on)}}$	$V_{\text{DD}}=15\text{V}$, $I_D=20\text{A}$, $V_{\text{GS}}=10\text{V}$, $R_G=1.8\Omega$	---	11	---	ns
Rise Time	T_r		---	8	---	
Turn-Off Delay Time	$T_{\text{d(off)}}$		---	26	---	
Fall Time	T_f		---	6	---	
Input Capacitance	C_{iss}	$V_{\text{DS}}=15\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$	---	1995	---	pF
Output Capacitance	C_{oss}		---	285	---	
Reverse Transfer Capacitance	C_{rss}		---	205	---	

Drain-Source Diode Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Continuous Source Current ¹	I_s	$V_G=V_D=0\text{V}$, Force Current	---	---	50	A
Diode Forward Voltage ²	V_{SD}	$V_{\text{GS}}=0\text{V}$, $I_s=20\text{A}$, $T_J=25^\circ\text{C}$	---	0.8	1.3	V
Reverse Recovery Time	t_{rr}	$I_F=20\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$, $T_J=25^\circ\text{C}$	---	18	---	nS
			---	14	---	nC
Reverse Recovery Charge	Q_{rr}					

Note:

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
2. The data tested by pulsed, pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$
3. The EAS data shows Max. rating. The test condition is $V_{\text{DD}}=15\text{V}$, $V_{\text{GS}}=10\text{V}$, $L=0.5\text{mH}$
4. The power dissipation is limited by 150°C junction temperature

Typical Characteristics

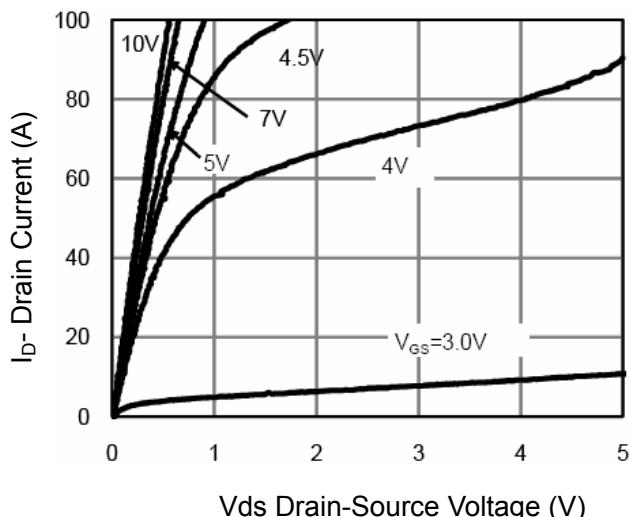


Figure 1 Output Characteristics

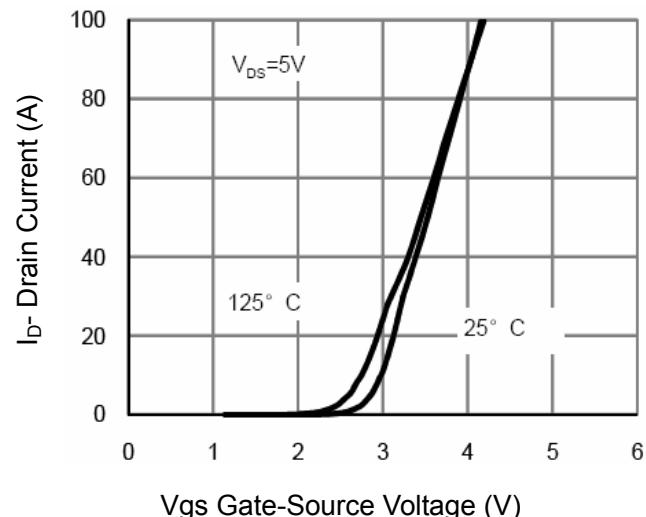


Figure 2 Transfer Characteristics

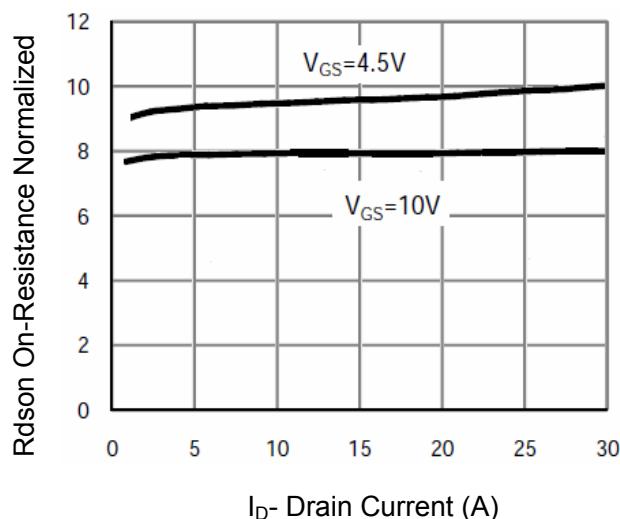


Figure 3 Rdson - Drain Current

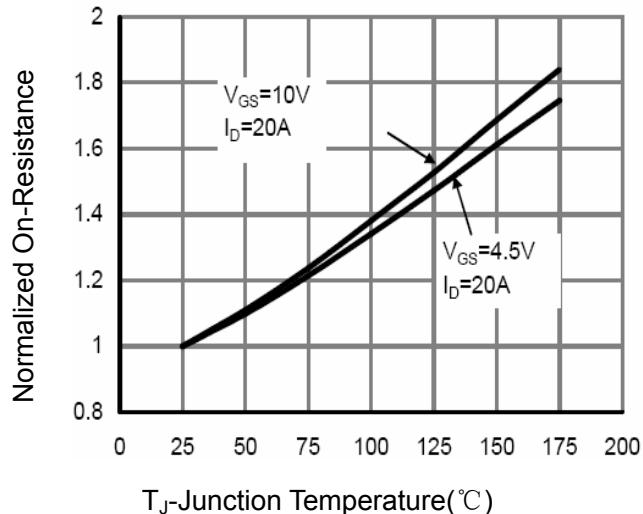


Figure 4 Rdson - Junction Temperature

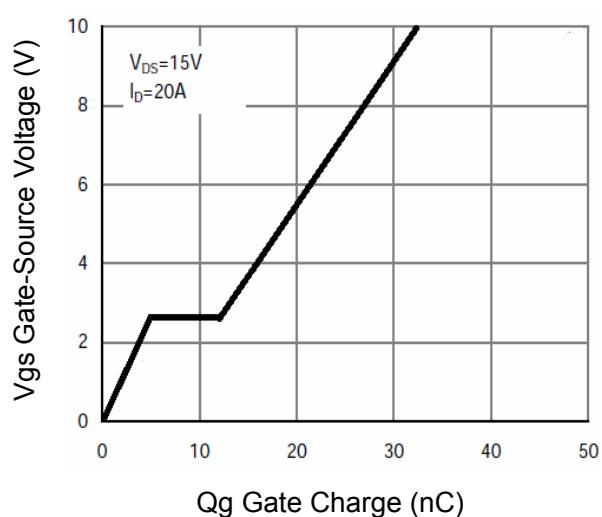


Figure 5 Gate Charge

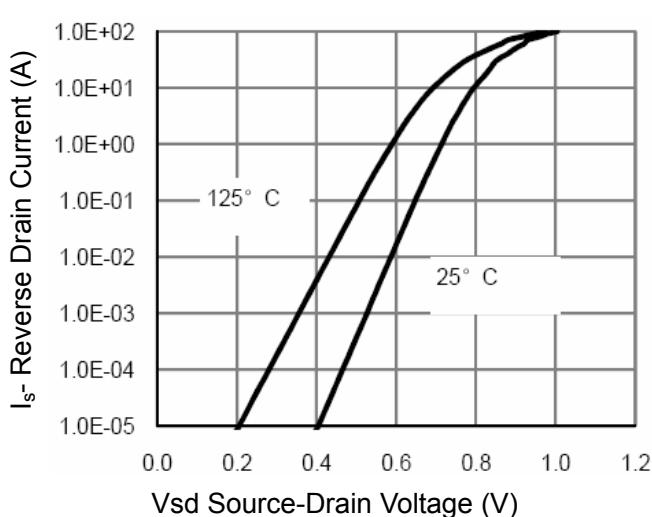
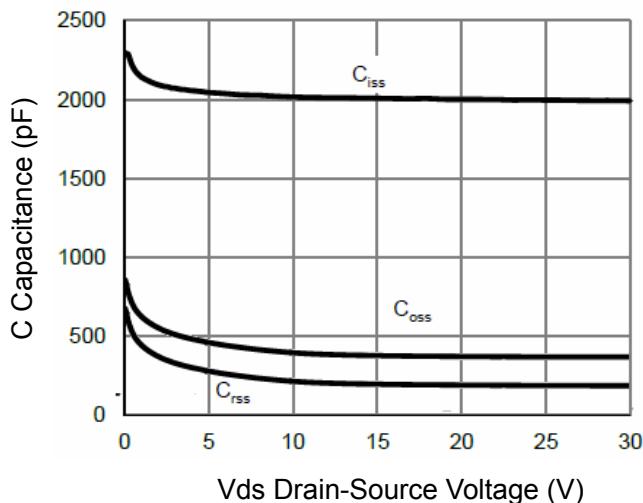
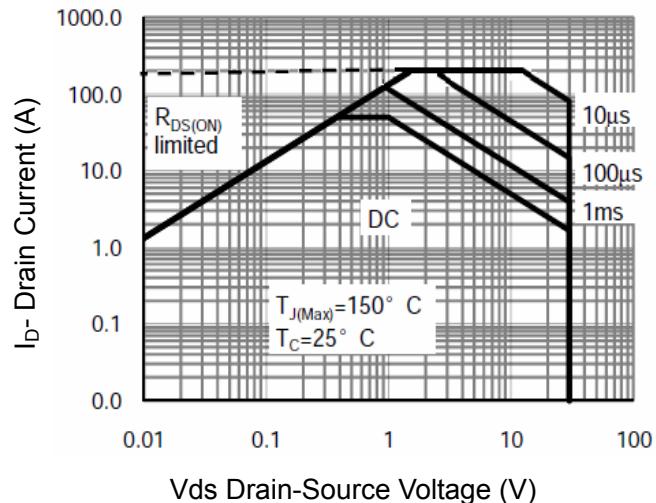
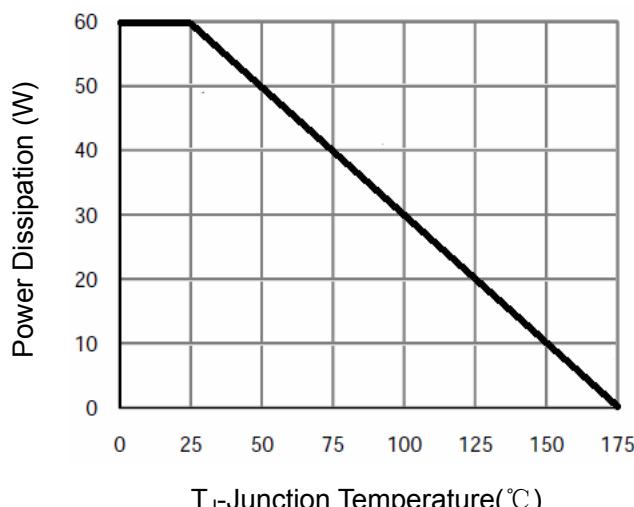
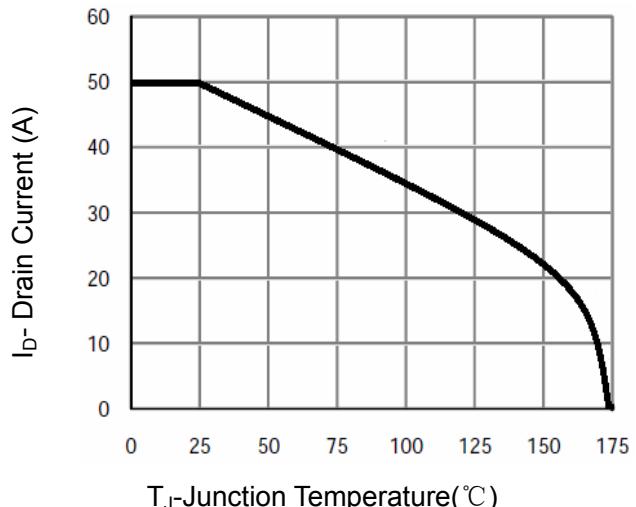
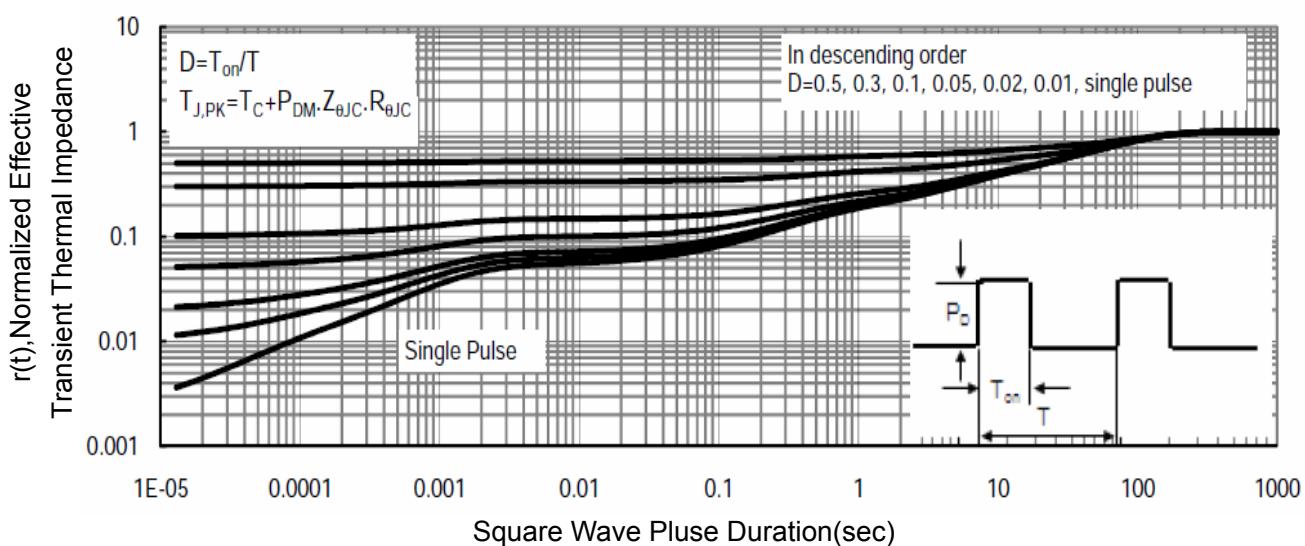
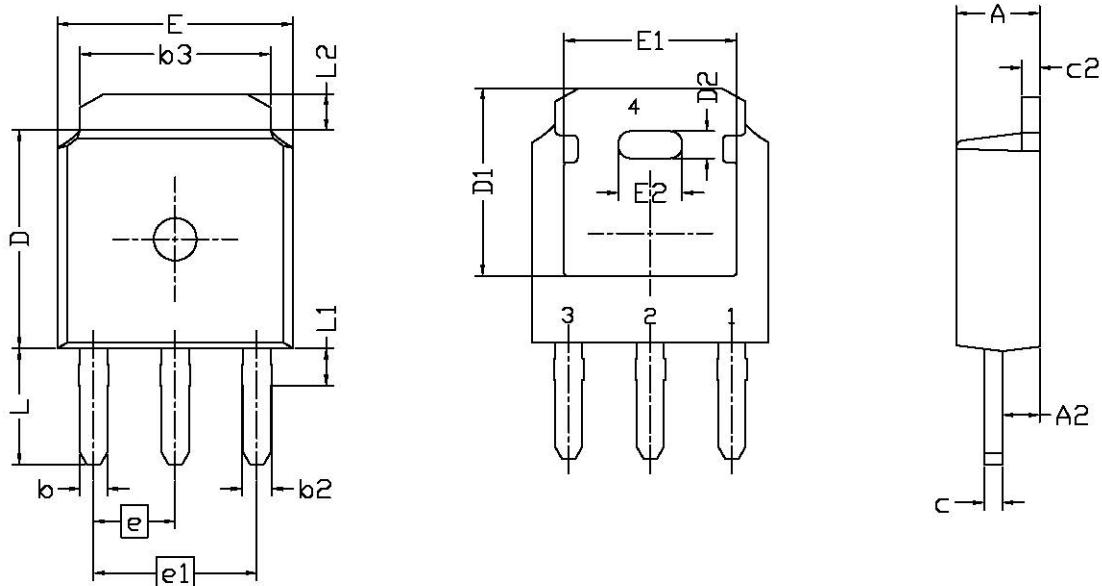


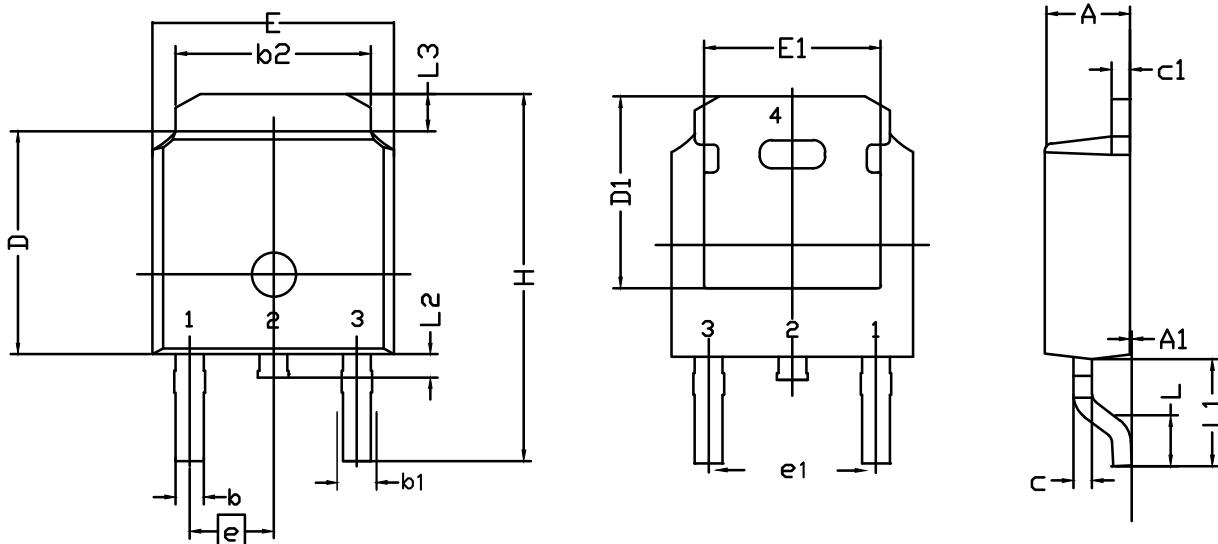
Figure 6 Source-Drain Diode Forward


Figure 7 Capacitance vs Vds

Figure 8 Safe Operation Area

Figure 9 Power De-rating

Figure 10 ID Current- Junction Temperature

Figure 11 Normalized Maximum Transient Thermal Impedance

TO-251 Package Outline Dimensions



Symbol	Dimensions (unit:mm)			Symbol	Dimensions (unit:mm)		
	Min	Typ	Max		Min	Typ	Max
A	2.20	2.30	2.39	A2	0.90	1.00	1.14
b	0.63	0.76	0.85	b2	0.76	0.85	1.05
b3	5.10	5.40	5.60	C	0.46	0.51	0.61
C2	0.46	0.51	0.61	D	5.90	6.10	6.30
D1	5.25 REF			D2	0.508 BSC		
E	6.35	6.55	6.70	E1	5.06 REF		
E2	1.524 BSC			e	2.29 BSC		
e1	4.57 BSC			L	3.70	4.00	4.40
L1	1.15 REF			L2	0.90	1.06	1.20

TO-252 Package Outline Dimensions


Symbol	Dimensions (unit:mm)			Symbol	Dimensions (unit:mm)		
	Min	Typ	Max		Min	Typ	Max
A	2.20	2.30	2.38	E	6.40	6.60	6.731
A₁	0.00	0.10	0.20	E₁	4.40	--	--
b	0.64	0.76	0.89	e	2.286 BSC		
b₁	0.77	0.85	1.14	e₁	4.572 BSC		
b₂	5.00	5.33	5.46	H	9.40	10.00	10.40
c	0.458	0.508	0.610	L	1.40	1.52	1.77
C₁	0.458	0.508	0.620	L₁	--	2.743	--
D	5.98	6.10	6.223	L₂	0.60	0.80	1.01
D₁	5.20	5.25	5.38	L₃	0.90	1.06	1.25